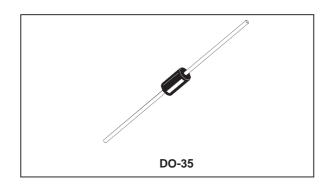


## SMALL SIGNAL SCHOTTKY DIODE

#### **DESCRIPTION**

General purpose metal to silicon diode featuring very low turn-on voltage and fast switching.

This device has integrated protection against excessive voltage such as electrostatic discharges.



## **ABSOLUTE RATINGS** (limiting values)

| Symbol                 | Parameter  | Value                        | Unit |
|------------------------|--|------------------------------|------|
| $V_{RRM}$              | Repetitive Peak Reverse Voltage                    | 100                          | V    |
| I <sub>F</sub>         | Forward Continuous Current*                        | 100                          | mA   |
| $I_{FRM}$              | Repetitive Peak Forward Current*                   | 350                          | mA   |
| I <sub>FSM</sub>       | Surge non Repetitive Forward Current*              | 750                          | mA   |
| P <sub>tot</sub>       | Power Dissipation*                                 | 100                          | mW   |
| T <sub>stg</sub><br>Tj | Storage and Junction Temperature Range             | - 65 to +150<br>- 65 to +125 | °C   |
| $T_L$                  | Maximum Lead Temperature for Soldering d from Case | 230                          | °C   |

#### THERMAL RESISTANCE

| Symbol               | Test Conditions   | Value | Unit |  |
|----------------------|-------------------|-------|------|--|
| R <sub>th(j-a)</sub> | Junction-ambient* | 300   | °C/W |  |

#### **ELECTRICAL CHARACTERISTICS**

## STATIC CHARACTERISTICS

| Symbol             | Test Conditions                      | Min. | Тур. | Max. | Unit |
|--------------------|--------------------------------------|------|------|------|------|
| $V_{BR}$           | $T_j = 25^{\circ}C$ $I_R = 100\mu A$ | 100  |      |      | V    |
| V <sub>F</sub> * * | $T_j = 25^{\circ}C$ $I_F = 1mA$      |      | 0.4  | 0.45 | V    |
|                    | $T_j = 25^{\circ}C$ $I_F = 200mA$    |      |      | 1    |      |
| I <sub>R</sub> * * | $T_{j} = 25^{\circ}C$ $V_{R} = 50V$  |      |      | 0.1  | μΑ   |
|                    | $T_j = 100^{\circ}C$                 |      |      | 20   |      |

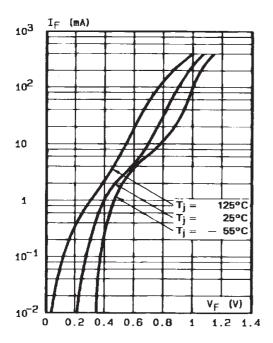
### DYNAMIC CHARACTERISTICS

| Symbol | Test Conditions       |            |          | Min. | Тур. | Max. | Unit |
|--------|-----------------------|------------|----------|------|------|------|------|
| С      | T <sub>j</sub> = 25°C | $V_R = 1V$ | f = 1MHz |      | 2    |      | pF   |

<sup>\*</sup> On infinite heatsink with 4mm lead length \* \* Pulse test:  $t_p\!\leq\!300\mu s~\delta\!<\!2\%.$ 

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**Fig. 1:** Forward current versus forward voltage at different temperatures (typical values).



**Fig. 2:** Forward current versus forward voltage (typical values).

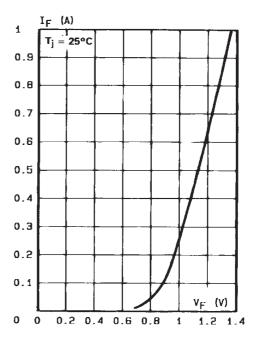
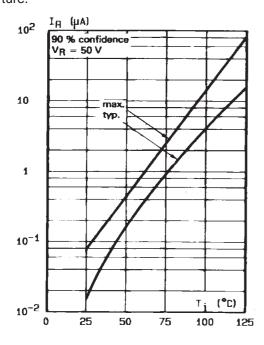


Fig. 3: Reverse current versus junction temperature.



**Fig. 4:** Reverse current versus continuous reverse voltage (typical values).

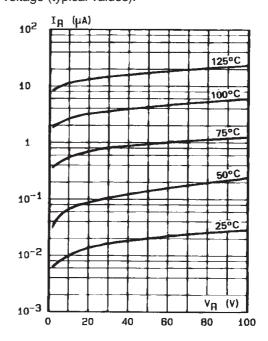
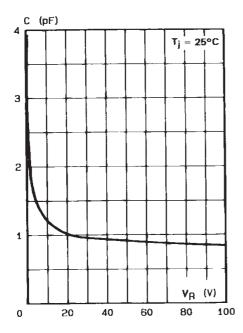
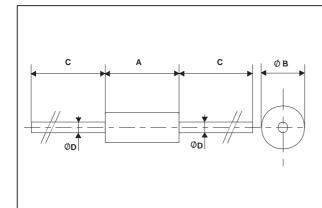


Fig. 5: Capacitance C versus reverse applied voltage  $\rm V_{\scriptscriptstyle R}$  (typical values).



#### **PACKAGE MECHANICAL DATA**

DO-35



| REF. | DIMENSIONS  |       |        |       |  |
|------|-------------|-------|--------|-------|--|
|      | Millimeters |       | Inches |       |  |
|      | Min.        | Max.  | Min.   | Max.  |  |
| А    | 3.05        | 4.50  | 0.120  | 0.177 |  |
| В    | 1.53        | 2.00  | 0.060  | 0.079 |  |
| С    | 28.00       |       | 1.102  |       |  |
| D    | 0.458       | 0.558 | 0.018  | 0.022 |  |

Cooling method: by convection and conduction

Marking: clear, ring at cathode end.

Weight: 0.15g

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